NX3L1G66

Low-voltage analog switch

Rev. 01 — 3 January 2008

Product data sheet

1. General description

The NX3L1G66 provides one single pole, single-throw analog switch function. It has two input/output terminals (Y and Z) and an active HIGH enable input pin (E). When E is LOW, the analog switch is turned off.

Schmitt trigger action at the enable input (E) makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 1.4 V to 3.6 V.

The NX3L1G66 allows signals with amplitude up to V_{CC} to be transmitted from Y to Z; or from Z to Y. Its low ON resistance (0.5 Ω) and flatness (0.13 Ω) ensures minimal attenuation and distortion of transmitted signals.

2. Features

- Wide supply voltage range from 1.4 V to 3.6 V
- Very low ON resistance (peak):
 - 1.6 Ω (typical) at $V_{CC} = 1.4 \text{ V}$
 - 1.0 Ω (typical) at $V_{CC} = 1.65 \text{ V}$
 - 0.55 Ω (typical) at $V_{CC} = 2.3 \text{ V}$
 - 0.50 Ω (typical) at $V_{CC} = 2.7 \text{ V}$
- High noise immunity
- ESD protection:
 - ◆ HBM JESD22-A114E Class 3A exceeds 7500 V
 - MM JESD22-A115-A exceeds 200 V
 - ◆ CDM AEC-Q100-011 revision B exceeds 1000 V
- CMOS low-power consumption
- Latch-up performance exceeds 100 mA per JESD 78 Class II Level B
- Direct interface with TTL levels at 3.0 V
- Control input accepts voltages above supply voltage
- High current handling capability (350 mA continuous current under 3.3 V supply)
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Applications

- Cell phone
- PDA
- Portable media player



4. Ordering information

Table 1. Ordering information

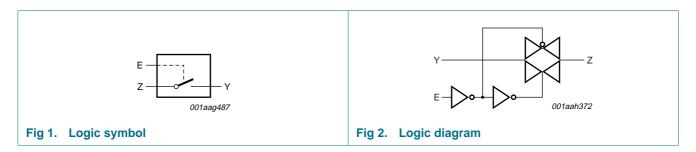
Type number	Package						
	Temperature range	Name	Description	Version			
NX3L1G66GM	–40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886			

5. Marking

Table 2. Marking

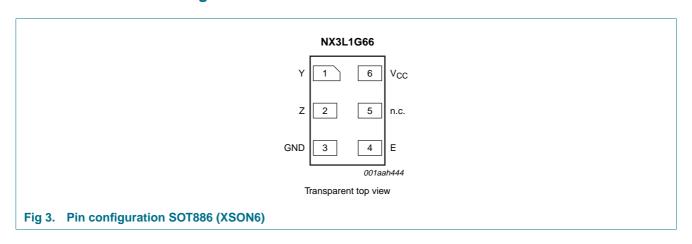
Type number	Marking code
NX3L1G66GM	DL

6. Functional diagram



7. Pinning information

7.1 Pinning



7.2 Pin description

Table 3. Pin description

Symbol	Pin	Description
Υ	1	independent input or output
Z	2	independent input or output
GND	3	ground (0 V)
E	4	enable input (active HIGH)
n.c.	5	not connected
V_{CC}	6	supply voltage

8. Functional description

Table 4. Function table[1]

Input E	Switch
L	OFF-state
Н	ON-state

^[1] H = HIGH voltage level;L = LOW voltage level

9. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V _{SW}	switch voltage		[2] -0.5	$V_{CC} + 0.5$	V
I _{IK}	input clamping current	$V_1 < -0.5 \text{ V}$	-50	-	mΑ
I _{SK}	switch clamping current	$V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$	-	±50	mΑ
I _{SW}	switch current	$V_{SW} > -0.5 \text{ V or } V_{SW} < V_{CC} + 0.5 \text{ V};$ source or sink current	-	±350	mA
		V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; pulsed at 1 ms duration, < 10% duty cycle; peak current	-	±500	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C}$	<u>[3]</u> -	250	mW

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

^[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

^[3] For XSON6 packages: above 45 °C the value of Ptot derates linearly with 2.4 mW/K.

10. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.4	-	3.6	V
V_{I}	input voltage	enable input E	0	-	3.6	V
V_{SW}	switch voltage		<u>[1]</u> 0	-	V_{CC}	V
T _{amb}	ambient temperature		-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$	[2] _	-	200	ns/V

^[1] To avoid sinking GND current from of terminal Z when switch current flows in terminal Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Y. In this case, there is no limit for the voltage drop across the switch.

11. Static characteristics

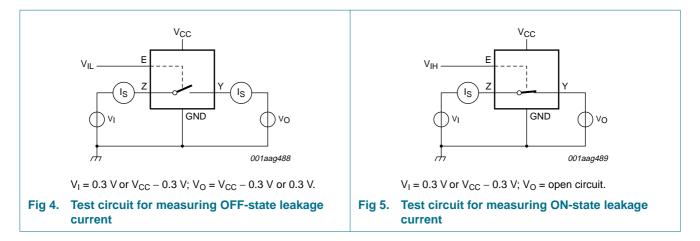
Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground 0 V).

Symbol	Parameter	r Conditions	25 °C			-40	Unit		
			Min	Тур	Max	Min	Max (85 °C)	Max (125 °C)	
V_{IH}	HIGH-level	$V_{CC} = 1.4 \text{ V to } 1.95 \text{ V}$	0.65V _{CC}	-	-	0.65V _{CC}	-	-	V
	input voltage	V _{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	-	V
V_{IL}	LOW-level	$V_{CC} = 1.4 \text{ V to } 1.95 \text{ V}$	-	-	$0.35V_{CC}$	-	$0.35V_{CC}$	$0.35V_{CC}$	V
	input voltage	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	0.7	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	8.0	V
I _I	input leakage current	enable input E; V_I = GND to 3.6 V; V_{CC} = 1.4 V to 3.6 V	-	-	-	-	±0.5	±1	μΑ
I _{S(OFF)}	OFF-state leakage current	Y port; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$ see Figure 4	-	-	±5	-	±50	±500	nA
I _{S(ON)}	ON-state leakage current	Z port; $V_{CC} = 1.4 \text{ V to } 3.6 \text{ V};$ see Figure 5	-	-	±5	-	±50	±500	nA
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $V_{CC} = 3.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$	-	-	100	-	690	6000	nA
C _I	input capacitance		-	1.0	-	-	-	-	pF
C _{S(OFF)}	OFF-state capacitance		-	35	-	-	-	-	pF
C _{S(ON)}	ON-state capacitance		-	110	-	-	-	-	pF

^[2] Applies to control signal levels.

11.1 Test circuits



11.2 ON resistance

Table 8. ON resistance

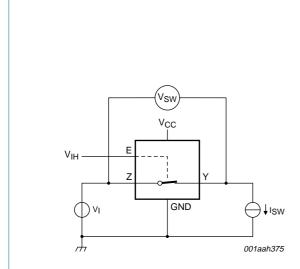
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see Figure 7 to Figure 12.

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			-40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
R _{ON(peak)}	ON resistance (peak)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA};$ $SEE = \frac{Figure 6}{2}$							
		V _{CC} = 1.4 V	-	1.6	3.7	-	4.1	Ω	
		V _{CC} = 1.65 V	-	1.0	1.6	-	1.7	Ω	
		$V_{CC} = 2.3 \text{ V}$	-	0.55	0.8	-	0.9	Ω	
		$V_{CC} = 2.7 \text{ V}$	-	0.5	0.75	-	0.9	Ω	
R _{ON(flat)}	ON resistance (flatness)	$V_I = GND \text{ to } V_{CC};$ $I_{SW} = 100 \text{ mA}$							
		V _{CC} = 1.4 V	-	1.0	3.3	-	3.6	Ω	
		V _{CC} = 1.65 V	-	0.5	1.2	-	1.3	Ω	
		$V_{CC} = 2.3 \text{ V}$	-	0.15	0.3	-	0.35	Ω	
		$V_{CC} = 2.7 \text{ V}$	-	0.13	0.3	-	0.35	Ω	

^[1] Typical values are measured at T_{amb} = 25 °C.

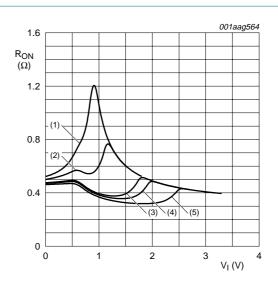
^[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.

11.3 ON resistance test circuit and graphs



 $R_{ON} = V_{SW} / I_{SW}$

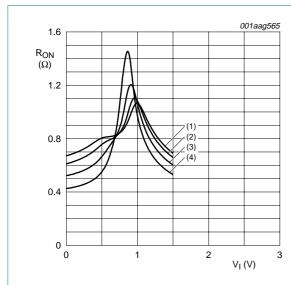
Fig 6. Test circuit for measuring ON resistance



- (1) $V_{CC} = 1.5 \text{ V}.$
- (2) $V_{CC} = 1.8 \text{ V}.$
- (3) $V_{CC} = 2.5 \text{ V}.$
- (4) $V_{CC} = 2.7 \text{ V}.$
- (5) $V_{CC} = 3.3 \text{ V}.$

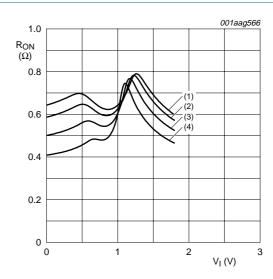
Measured at $T_{amb} = 25$ °C.

Fig 7. Typical ON resistance as a function of input voltage



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

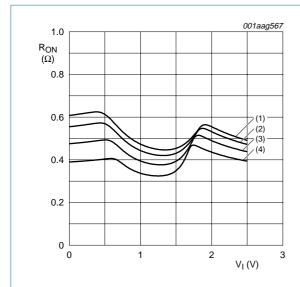
Fig 8. ON resistance as a function of input voltage; $V_{CC} = 1.5 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

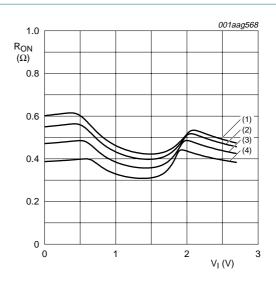
Fig 9. ON resistance as a function of input voltage; $V_{CC} = 1.8 \text{ V}$

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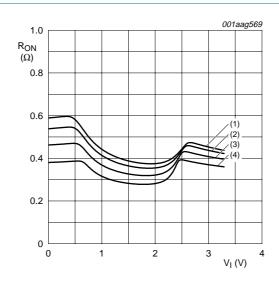
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 10. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}$



- (1) $T_{amb} = 125 \,^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 11. ON resistance as a function of input voltage; $V_{CC} = 2.7 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 12. ON resistance as a function of input voltage; V_{CC} = 3.3 V

12. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for load circuit see Figure 14.

Symbol	Parameter	Conditions		25 °C			°C to +12	5 °C	Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t _{en}	enable time	E to Z or Y; see Figure 13							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	27	41	-	44	48	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	22	27	-	34	36	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	17	20	-	27	30	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	14	18	-	24	26	ns
t _{dis}	disable time	E to Z or Y; see Figure 13							
		$V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$	-	9	18	-	19	21	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$	-	7	13	-	15	16	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	4	8	-	9	10	ns
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	4	8	-	8	9	ns

^[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.5 V, 1.8 V, 2.5 V and 3.3 V respectively.

12.1 Waveform and test circuits

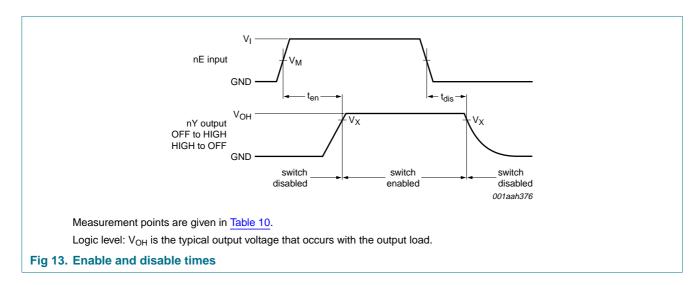


Table 10. Measurement points

Supply voltage	Input	Output
V _{CC}	V _M	V _X
1.4 V to 3.6 V	0.5V _{CC}	0.9V _{OH}

NX3L1G66

Low-voltage analog switch

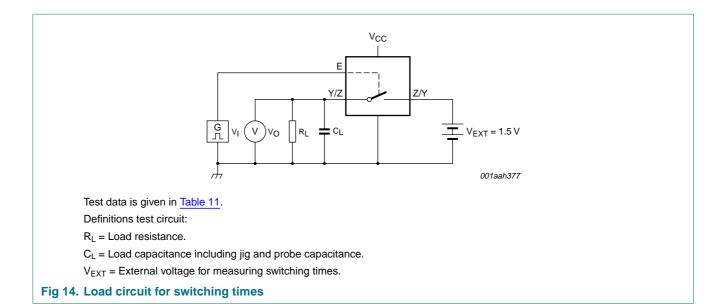


Table 11. Test data

Supply voltage	Input		Load			
V _{CC}	VI	t _r , t _f	CL	R _L		
1.4 V to 3.6 V	V _{CC}	≤ 2.5 ns	35 pF	50 Ω		

12.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_I = GND or V_{CC} (unless otherwise specified); t_r = $t_f \le 2.5$ ns.

Symbol	Parameter	Conditions		25 °C			Unit
				Min	Тур	Max	
THD	total harmonic	f_i = 20 Hz to 20 kHz; R_L = 32 Ω ; see Figure 15	<u>[1]</u>				
	distortion	$V_{CC} = 1.4 \text{ V}; V_I = 1 \text{ V (p-p)}$		-	0.15	-	%
		$V_{CC} = 1.65 \text{ V}; V_I = 1.2 \text{ V (p-p)}$		-	0.10	-	%
		$V_{CC} = 2.3 \text{ V}; V_I = 1.5 \text{ V (p-p)}$		-	0.015	-	%
		$V_{CC} = 2.7 \text{ V}; V_I = 2 \text{ V (p-p)}$		-	0.024	-	%
f _(-3dB)	-3 dB frequency	$R_L = 50 \Omega$; see Figure 16	<u>[1]</u>				
	response	V _{CC} = 1.4 V to 3.6 V		-	60	-	MHz
α_{iso}	isolation (OFF-state)	f_i = 100 kHz; R_L = 50 Ω ; see Figure 17	<u>[1]</u>				
		V _{CC} = 1.4 V to 3.6 V		-	-90	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1$ MHz; $C_L = 50$ pF; $R_L = 50$ Ω ; see Figure 18					
		$V_{CC} = 1.4 \text{ V to } 3.6 \text{ V}$		-	0.16	-	V

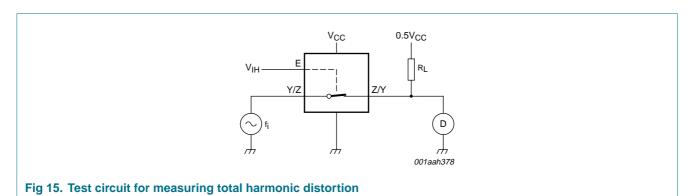
 Table 12.
 Additional dynamic characteristics ... continued

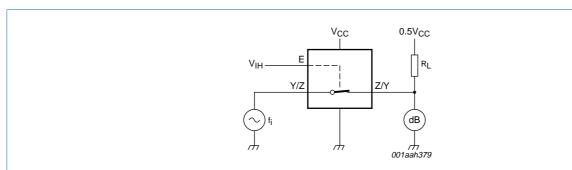
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); V_I = GND or V_{CC} (unless otherwise specified); t_r = $t_f \le 2.5$ ns.

Symbol	Parameter	Conditions		25 °C		
			Min	Тур	Max	
Q _{inj}	charge injection	f_i = 1 MHz; C_L = 0.1 nF; R_L = 1 M Ω ; V_{gen} = 0 V; R_{gen} = 0 Ω ; see Figure 19			'	
		V _{CC} = 1.5 V	-	3	-	рС
		V _{CC} = 1.8 V	-	3	-	рС
		V _{CC} = 2.5 V	-	3	-	рС
		V _{CC} = 3.3 V	-	3	-	рС

[1] f_i is biased at 0.5 V_{CC} .

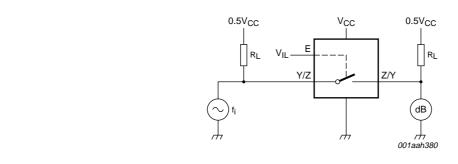
12.3 Test circuits





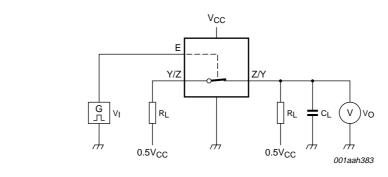
Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads -3 dB.

Fig 16. Test circuit for measuring the frequency response when channel is in ON-state

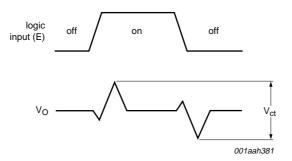


Adjust fi voltage to obtain 0 dBm level at input.

Fig 17. Test circuit for measuring isolation (OFF-state)

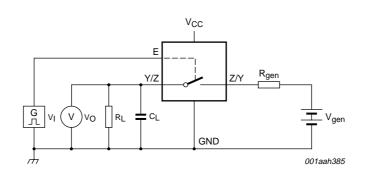


a. Test circuit

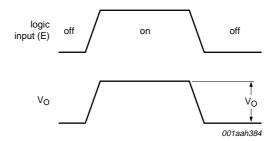


b. Input and output pulse definitions

Fig 18. Test circuit for measuring crosstalk voltage between digital inputs and switch



a. Test circuit



b. Input and output pulse definitions

Definition: $Q_{inj} = \Delta V_O \times C_L$.

 ΔV_{O} = output voltage variation.

R_{gen} = generator resistance.

V_{gen} = generator voltage.

Fig 19. Test circuit for measuring charge injection

13. Package outline

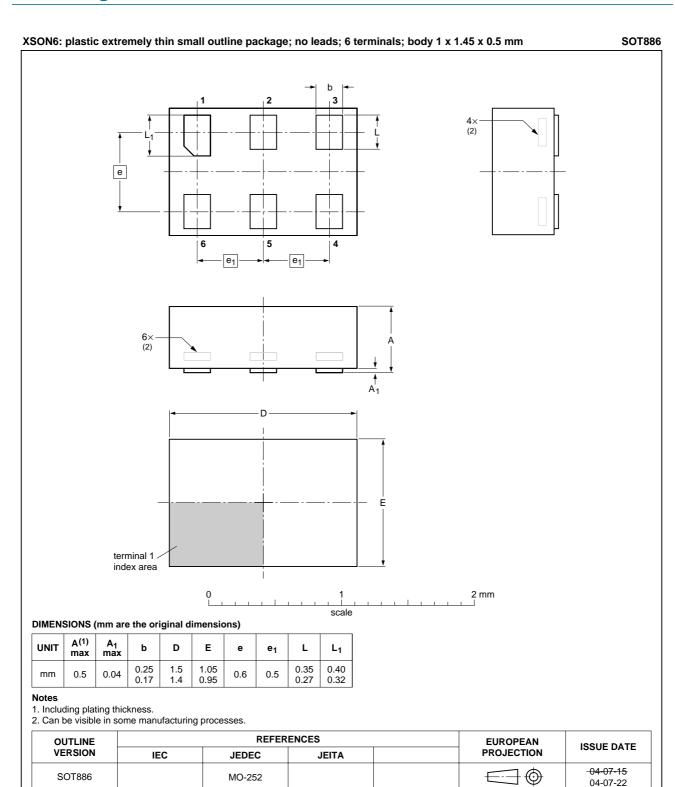


Fig 20. Package outline SOT886 (XSON6)

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14. Abbreviations

Table 13. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

15. Revision history

Table 14. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
NX3L1G66_1	20080103	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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NXP Semiconductors NX3L1G66

Low-voltage analog switch

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